

Design Note Overview

1 Introduction

This document contains an overview of the different design notes available. The design notes are divided into six different

categories; RF, SoC, MAC, Tools, Systems, and CC11xx/CC25xx Digital Features.

| Category | Numbering |
|--------------------------------|---------------|
| RF | DN001 – DN099 |
| SoC | DN100 – DN199 |
| MAC and ZigBee | DN200 – DN299 |
| Tools | DN300 – DN399 |
| System | DN400 – DN499 |
| CC11xx/CC25xx Digital Features | DN500 – DN599 |

Table 1. Numbering Overview

Table of Contents

| | | |
|----------|-----------------------------------|----------|
| 1 | INTRODUCTION..... | 1 |
| 2 | DESIGN NOTE OVERVIEW | 3 |
| 3 | GENERAL INFORMATION | 6 |
| 3.1 | DOCUMENT HISTORY..... | 6 |

2 Design Note Overview

| DN Number | Title | Keywords |
|-----------|---|---|
| DN001 | Antenna Measurement with Network Analyzer | Antenna, Network Analyzer, Measure, Return Loss, Reflection, Impedance |
| DN002 | Practical Sensitivity Testing | Receiver Testing, Sensitivity, PER (Packet Error Rate), BER (Bit Error Rate) |
| DN003 | Implementation of Microstrip Balun for CC2420, CC243x, and CC2480 | Balun, Microstrip, CAD Tool, DXF, Gerber, CC2420, CC2430, CC2431, CC2480 |
| DN004 | Folded Dipole Antenna for CC25xx | CC2500, CC2510, CC2511, CC2550, Folded Dipole, PCB Antenna, 2.4 GHz |
| DN005 | CC11xx Sensitivity versus Frequency Offset and Crystal Accuracy | Sensitivity, Frequency Offset, Crystal Accuracy, PER (Packet Error Rate), CC1100, CC1101, CC1110, CC1111 |
| DN006 | CC11XX Settings for FCC 15.247 Solutions | FCC 15.247 and 15.249, Wideband Requirements, CC11xx System parameters, AN001 SRD Regulations, Digital Modulation |
| DN007 | 2.4 GHz Inverted F Antenna | CC2400, CC2420, CC2430, CC2431, CC2500, CC2510, CC2511, CC2550, CC2520, CC2480, PCB Antenna, 2.4 GHz, Inverted F Antenna |
| DN008 | 868 MHz and 915 MHz PCB Antenna | CC1000, CC1010, CC1020, CC1021, CC1050, CC1070, CC1100, CC1150, PCB Antenna, 868 MHz, 915 MHz, Monopole |
| DN009 | Upgrade from CC1100 to CC1101 | RF transceiver, CC1100, CC1101 |
| DN010 | Close-in Reception with CC1101 | CC1101, Close-in Reception, Saturation |
| DN011 | RF Module Testing using SmartRF® Studio | Take Advantage of the Development Tools, Simplify Module Verification |
| DN012 | Programming Output Power on CC1100 and CC1150 | PATABLE Register Settings, Output Power Levels, Current Consumption, CC1100, CC1150 |
| DN013 | Programming Output Power on CC1101 | PATABLE Register Settings, Output Power Levels, Current Consumption, CC1101 |
| DN014 | Programming Output Power on CC2500 and CC2550 | PATABLE Register Settings, Output Power Levels, Current Consumption, CC2500, CC2550 |
| DN015 | Permanent Frequency Offset Compensation | Frequency Offset Compensation, Component Tolerance/Accuracy, Permanent Compensation, Compensation Span, Centre Frequency, Receive, CC1100, CC1101, CC1110, CC1111, CC2500, CC2510, CC2511 |
| DN016 | Compact 868/915 MHz Antenna Design | CC1100, CC1101, CC1110, CC1111, CC1150, Chip Antenna, 868 MHz, 915 MHz, ISM Bands, Johanson Technology |
| DN017 | CC11xx 868/915 MHz RF Matching | Balun, Reference Design, RF Matching, Impedance, Filter, CC1100, CC1101, CC1110, CC1111, CC1150 |
| DN018 | Range Measurements in an Open Field Environment | Friis Equation, Ground Model, Range, Sensitivity, Transmission Budget |
| DN020 | Programming Output Power on CC243x | TXCTRL, Output Power Level, Harmonics, Error Vector Magnitude, Current Consumption, CC2430, CC2431 |
| DN021 | CC2500 and CC2510/CC2511 Sensitivity versus Frequency Offset and Crystal Accuracy | Sensitivity, Frequency Offset, Crystal Accuracy, PER (Packet Error Rate), CC2500, CC2510, CC2511 |

Design Note DN000

| | | |
|-------|---|--|
| DN100 | Executing Program Code from RAM | Obsolete |
| DN101 | Using the ADC to Measure Supply Voltage | ADC, VDD, Supply Voltage, CC1110, CC1111, CC2430, CC2431, CC2510, CC2511 |
| DN102 | SoC Temperature Sensor | Temperature Sensor, ADC, CC1110, CC1111, CC2430, CC2510, CC2511 |
| DN103 | Optimizing Current Consumption in TX and RX | Obsolete. Replaced by DN106. |
| DN104 | Memory and Register Content After Reset | Obsolete. Info added to datasheets |
| DN105 | Upgrade from CC2510/11 Preview to Release part | CC2510, CC2511, External Interrupts, Software Changes, Hardware Changes |
| DN106 | Power Modes in CC111xFx, CC243x, and CC251xFx | Power Modes, Data Sheet, Errata Note, Work around, Interrupt Service Routine, External Port Interrupt, Sleep Timer Interrupt, CC1110, CC1111, CC2430, CC2431, CC2510, CC2511 |
| DN107 | DMA and Radio Configuration | DMA, Packet Handling Configuration, Radio, CC1110, CC1111, CC2510, CC2511 |
| DN108 | Using AES Encryption in CC11xFx, CC243x, and CC251xFx | AES, Encryption, Decryption, Initialization vector (IV)/nonce, Download/Upload, DMA, Interrupt Service Routine, CC1110, CC1111, CC2430, CC2431, CC2510, CC2511 |
| DN109 | DN109 Using I2S in CC111xFx and CC251xFx | I2S, CPU, DMA, Audio, Codec, Protocol, μ -Law Compression/Expansion, Sample Rate, Stereo/Mono, Word Select (Left/Right Audio Channel), CC1110, CC1111, CC2510, CC2511 |
| DN200 | Using Constants in Code with Z-Stack | Z-stack, XDATA, Code, IAR Embedded, CC2430, CC2431 |
| DN201 | Using the Direct Join Request Feature in Z-Stack | CC2420, CC2430, CC2431, Z-stack, Direct Join, Orphan, IAR Embedded Workbench |
| DN300 | SmartRF04 [®] EB Troubleshooting | SmartRF04 [®] EB, EM, CC1100, CC1110, CC1150, CC2430, CC2431, CC2500, CC2510, CC2511, CC2550 |
| DN301 | Code Export from SmartRF [®] Studio | SmartRF [®] Studio, Code Export, Register View |
| DN302 | Register View in SmartRF [®] Studio | SmartRF [®] Studio, Register View, Link |
| DN303 | Cleanup of Installed PC tools | SmartRF [®] Studio, Packet Sniffer, SmartRF [®] Flash Programmer, Remove, Clean up, PC Tools, Development Tools, Drivers, Windows Registers |
| DN400 | Interfacing CC1100 - CC2500 to the MSP430 | MSP430, CC1100, CC2500, Application Example, Interfacing CC1100 using SPI, MSP430 with SmartRF04 [®] EB, Library for CC1100 and CC2500 |
| DN401 | Interfacing CC1020/1 to the MSP430 | MSP430, CC1020, CC1021, CC1070, Application Example, MSP430 and SmartRF [®] 04EB, Interfacing CC1020 using SPI, Protocol Example |
| DN402 | Simple Audio Loopback Using CC251X | ADC, DAC, μ Law, CC2510, CC2511 |
| DN500 | Packet Transmission Basics | CC1100, CC1101, CC1150, CC2500, CC2550, FIFO, Fixed Packet Length Mode, Variable Packet Length Mode, Infinite Packet Length Mode |
| DN501 | PATABLE Access | CC1100, CC1101, CC1150, CC2500, CC2550, PATABLE |
| DN502 | CRC Implementation | CC1100, CC1101, CC1110, CC1111, CC1150, CC2500, CC2510, CC2511, CC2550, CRC |
| DN503 | SPI Access | CC1100, CC1101, CC1150, CC2500, CC2550, SPI, Reset, Burst Access, Command Strokes |
| DN504 | FEC Implementation | CC1100, CC1101, CC1110, CC1111, CC1150, CC2500, CC2510, CC2511, CC2550, FEC, Viterbi, Trellis |

Design Note DN000

| | | |
|-------|--------------------------------|--|
| DN505 | RSSI Interpretation and Timing | CC1100, CC1101, CC1110, CC1111, CC2500, CC2510, CC2511, RSSI |
| DN506 | GDO Pin Usage | CC1100, CC1101, CC1150, CC2500, CC2550, GDO Pin, RXFIFO_OVERFLOW, TXFIFO_UNDERFLOW |

Table 2. Design Note Overview

3 General Information

3.1 Document History

| Revision | Date | Description/Changes |
|----------|------------|--|
| SWRA120I | 2008.04.04 | Added CC2480 to DN003 and DN007. Added DN021 |
| SWRA120H | 2008.02.01 | Added DN017 |
| SWRA120G | 2008.01.24 | Added DN108 |
| SWRA120F | 2008.01.11 | Added DN018 |
| SWRA120E | 2007.12.21 | Added DN106, DN107, and DN020 |
| SWRA120D | 2007.10.22 | Added DN105, DN015, DN016, DN300, and DN301. DN100, DN103, and DN104 have been removed from the web and are therefore marked as Obsolete. Removed logo from header. |
| SWRA120C | 2007.10.09 | Added DN201, DN010, DN009, DN011, DN012, DN013, and DN014. |
| SWRA120B | 2007.04.16 | Added DN007, DN008, and DN402. Added ZigBee to the MAC category |
| SWRA120A | 2007.02.01 | Added DN006 |
| SWRA120 | 2006.07.06 | Initial release. |

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products

| | |
|-----------------------------|--|
| Amplifiers | amplifier.ti.com |
| Data Converters | dataconverter.ti.com |
| DSP | dsp.ti.com |
| Clocks and Timers | www.ti.com/clocks |
| Interface | interface.ti.com |
| Logic | logic.ti.com |
| Power Mgmt | power.ti.com |
| Microcontrollers | microcontroller.ti.com |
| RFID | www.ti-rfid.com |
| RF/IF and ZigBee® Solutions | www.ti.com/lprf |

Applications

| | |
|--------------------|--|
| Audio | www.ti.com/audio |
| Automotive | www.ti.com/automotive |
| Broadband | www.ti.com/broadband |
| Digital Control | www.ti.com/digitalcontrol |
| Medical | www.ti.com/medical |
| Military | www.ti.com/military |
| Optical Networking | www.ti.com/opticalnetwork |
| Security | www.ti.com/security |
| Telephony | www.ti.com/telephony |
| Video & Imaging | www.ti.com/video |
| Wireless | www.ti.com/wireless |

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2008, Texas Instruments Incorporated